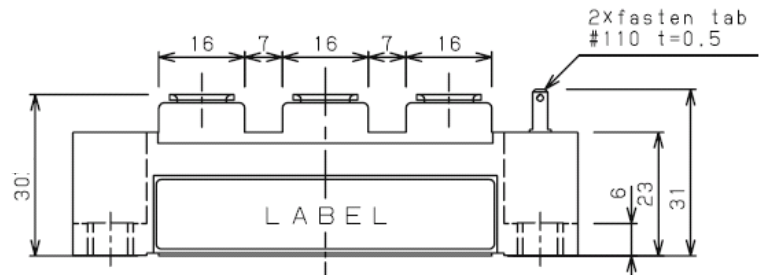
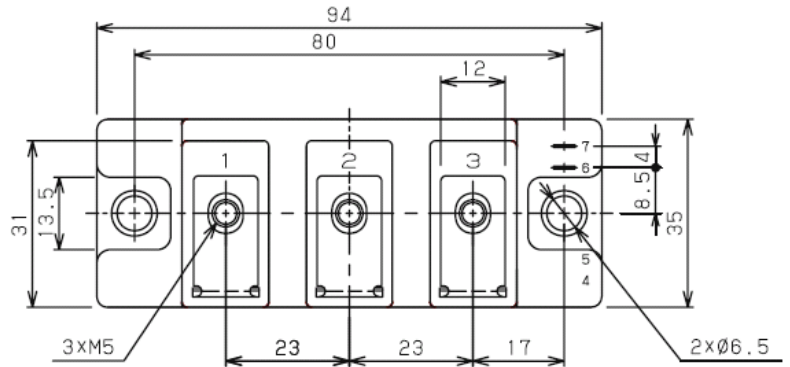
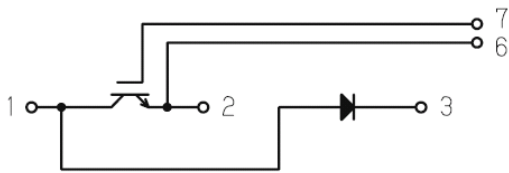


□ 回路図 : *CIRCUIT*

□ 概略図 : *SCHEMATIC DIAGRAM*

Dimension: [mm]



□ 最大定格 : *MAXIMUM RATINGS* (at $T_c=25^\circ\text{C}$ unless otherwise specified)

	Item	Symbol	Condition	Rated Value	Unit	
IGBT	コレクタ・エミッタ間電圧 Collector-Emitter Voltage	V_{CES}	G-E Short	650	V	
	ゲート・エミッタ間電圧 Gate-Emitter Voltage	V_{GES}	C-E Short	± 20	V	
	コレクタ電流 Collector Current	I_C	DC $T_c=85^\circ\text{C}$	75	A	
		I_{CP}	Pulse $\leq 1\text{ms}$	150		
	コレクタ損失 Collector Power Dissipation	P_C	$T_j=175^\circ\text{C}$	306	W	
			$T_j=150^\circ\text{C}$	255		
FWD	繰り返しピーク逆電圧 Repetitive peak reverse voltage	V_{RRM}		650	V	
	順電流 Forward Current	I_F		75	A	
		I_{FM}	Pulse $\leq 1\text{ms}$	150		
	最大接合温度 Maximum Junction Temperature	T_{jMAX}	瞬時動作(過負荷) Instantaneous Overload	175	$^\circ\text{C}$	
	接合温度範囲 Junction Temperature Range	T_j		$-40\sim+150$	$^\circ\text{C}$	
	保存温度範囲 Storage Temperature Range	T_{stg}		$-40\sim+125$	$^\circ\text{C}$	
	絶縁耐圧 Isolation Voltage	V_{ISO}	Terminal to Base AC, 1minute	2,500	V (RMS)	
	締め付けトルク Mounting Torque	Module Base to Heatsink	F_{tor}	M6	3	N·m
		Busbar to Main Terminal		M5	2	

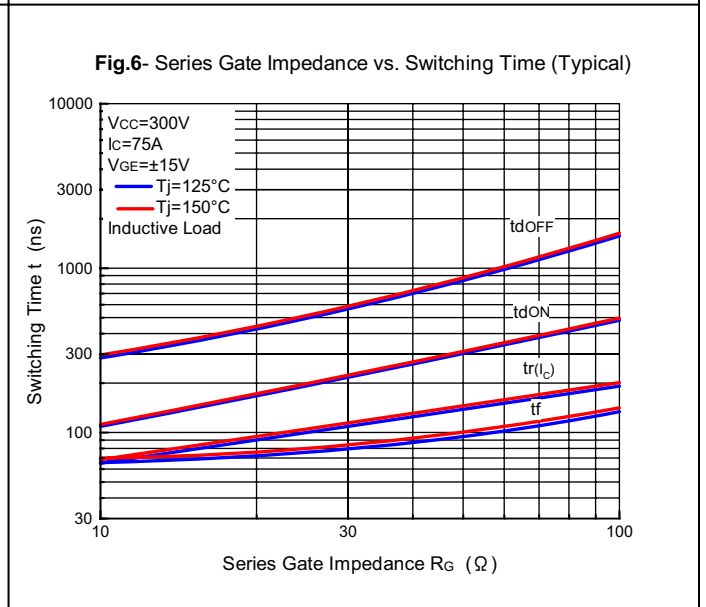
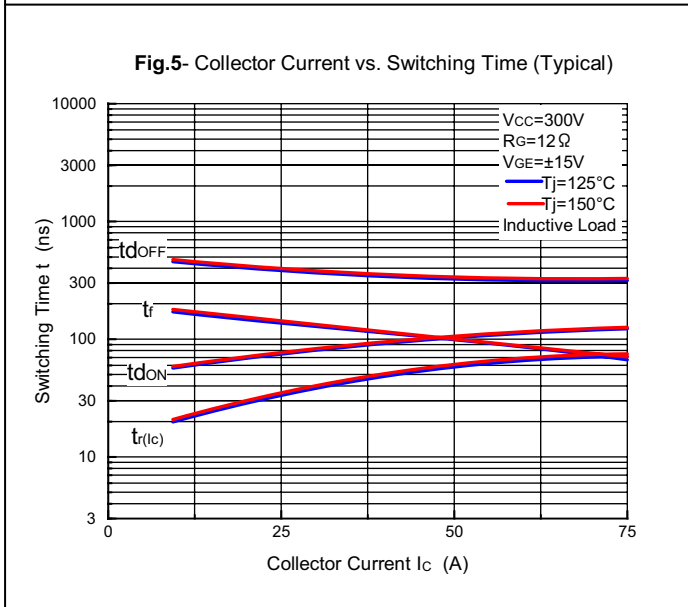
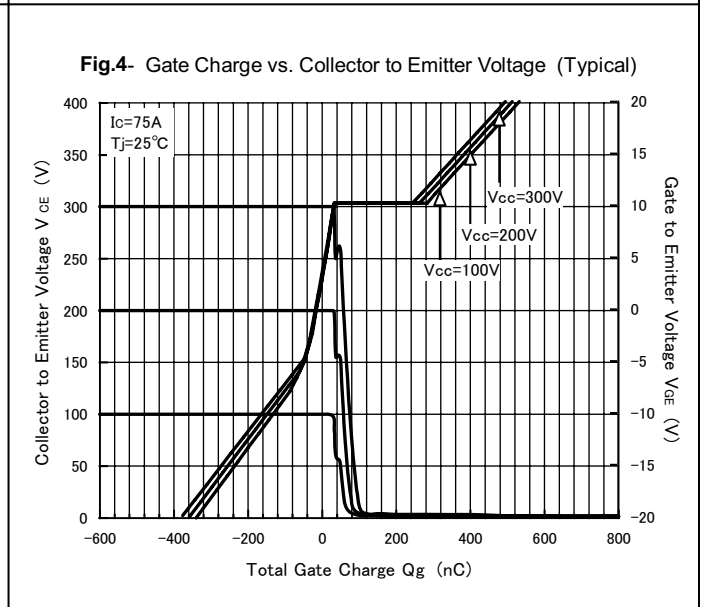
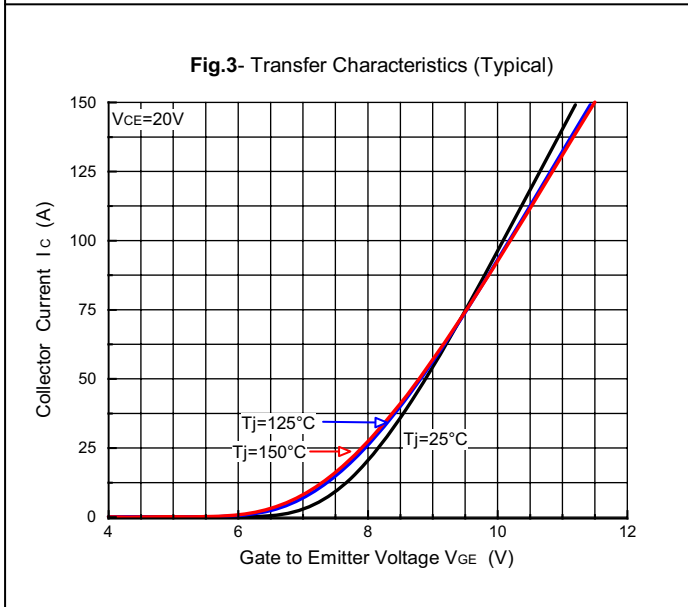
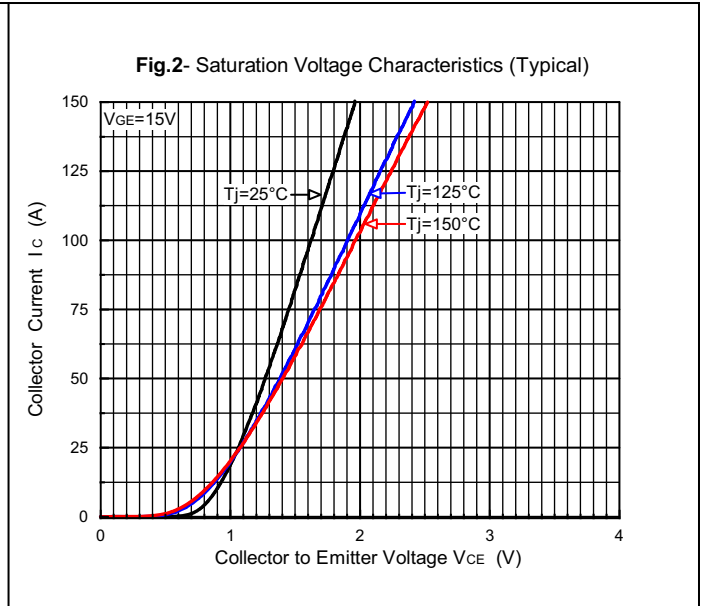
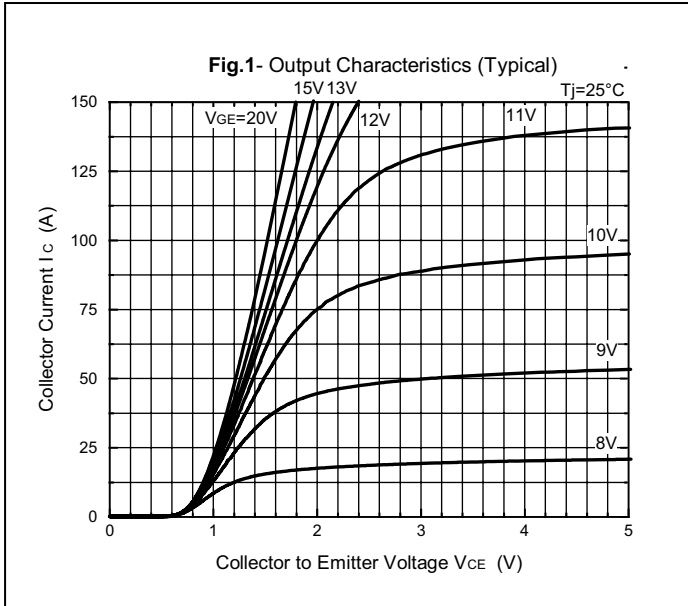
□ 電 氣 的 特 性 : **ELECTRICAL CHARACTERISTICS** (at $T_J=25^\circ\text{C}$ unless otherwise specified)

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit		
IGBT	コレクタ遮断電流 Collector-Emitter Cut-Off Current	ICES	$V_{CE}=650V, V_{GE}=0V$	—	—	1.0	mA		
	ゲート漏れ電流 Gate-Emitter Leakage Current	IGES	$V_{GE}=\pm 20V, V_{CE}=0V$	—	—	1.0	μA		
	コレクタ・エミッタ間飽和電圧 Collector-Emitter Saturation Voltage	$V_{CE(sat.)}$	$I_C=75A, V_{GE}=15V$ (chip level)	$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$ $T_J=150^\circ\text{C}$	— — —	1.45 1.65 1.70	1.95 — —	V	
	ゲートしきい値電圧 Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE}=10V, I_C=1.5mA$		4.8	—	7.0	V	
	入力容量 Input Capacitance	Cies	$V_{CE}=25V, V_{GE}=0V, f=1MHz$		—	6.6	—	nF	
	出力容量 Output Capacitance	Coes			—	0.3	—		
	帰還容量 Reverse Transfer Capacitance	Cres			—	0.2	—		
	ゲート電荷量 Gate Charge	Qg	$V_{CC}=300V, I_C=75A, V_{GE}=-15\sim+15V$		—	660	—	nC	
	スイッチング時間 Switching Time	上昇時間 Rise Time	tr	$V_{CC}=300V, L_s=38nH$ $I_C=75A$ Inductive Load		—	75	—	ns
		ターンオン遅延時間 Turn-on Delay Time	td(on)	$R_G=12\Omega$ $V_{GE}=\pm 15V$ $T_J=150^\circ\text{C}$		—	126	—	
下降時間 Fall Time		tf			—	71	—		
ターンオフ遅延時間 Turn-off Delay Time		td(off)			—	328	—		
FWD	順電圧 Peak Forward Voltage	V_F	$I_F=75A, V_{GE}=0V$ (chip level)	$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$ $T_J=150^\circ\text{C}$	— — —	1.70 1.60 1.55	2.20 — —	V	
	逆回復時間 Reverse Recovery Time	t _{rr}	$V_{CC}=300V, L_s=38nH$ $I_C=75A$ Inductive Load $R_G=12\Omega$ $V_{GE}=\pm 15V$ $T_J=150^\circ\text{C}$		—	140	—	ns	
内部配線抵抗 Internal Lead Resistance		R_{CC+EE}	主端子—チップ間 / 1素子 Main Terminal - Chip / Per 1 Arm		—	—	1	m Ω	
内部インダクタンス Stray Inductance		LSCE	メイン端子3—2間 Main Terminal 3 - Main Terminal 2		—	30	—	nH	

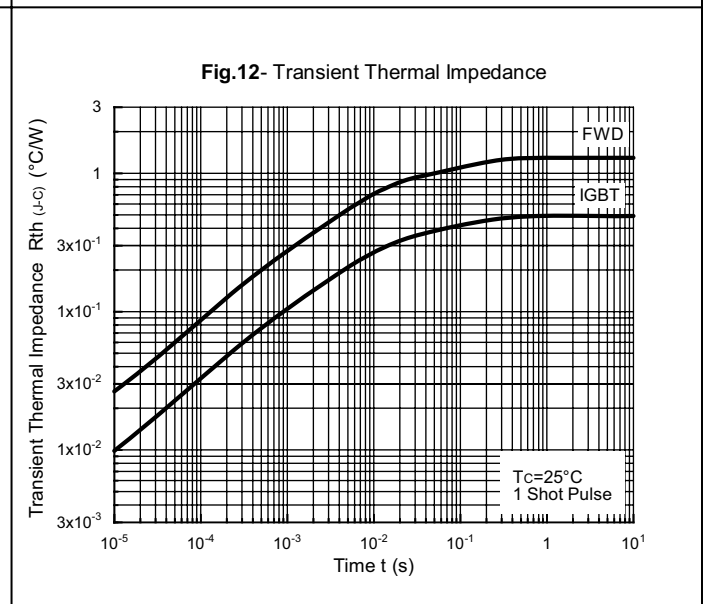
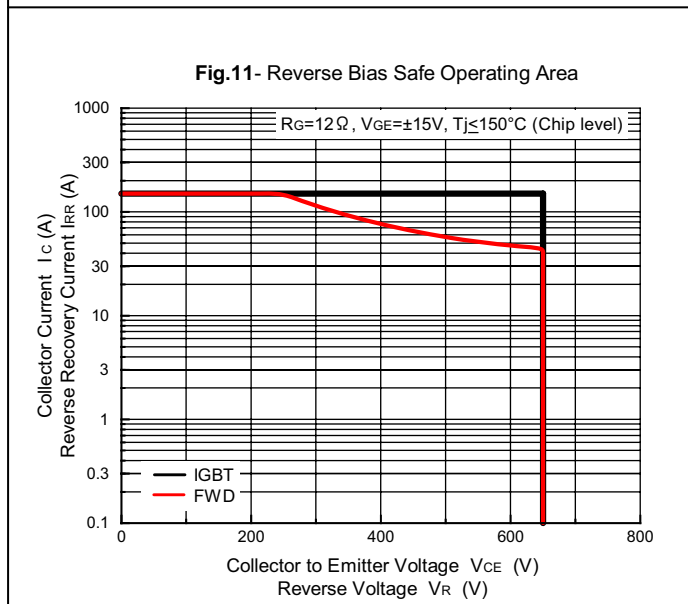
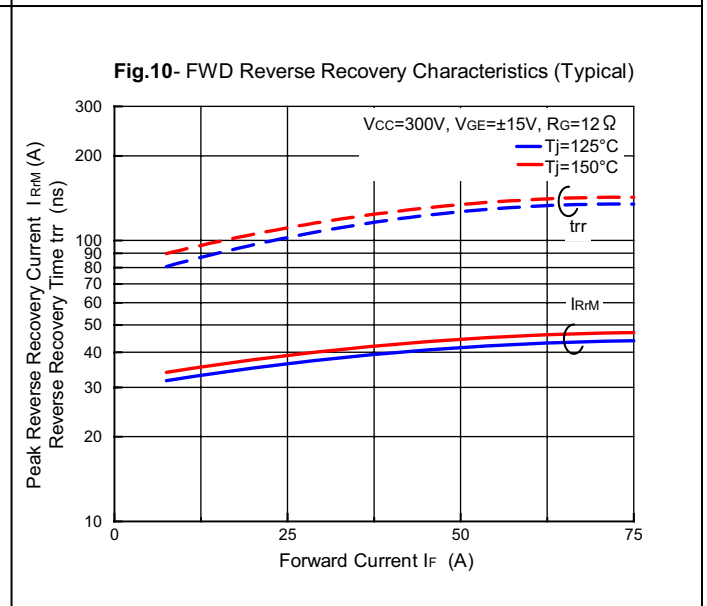
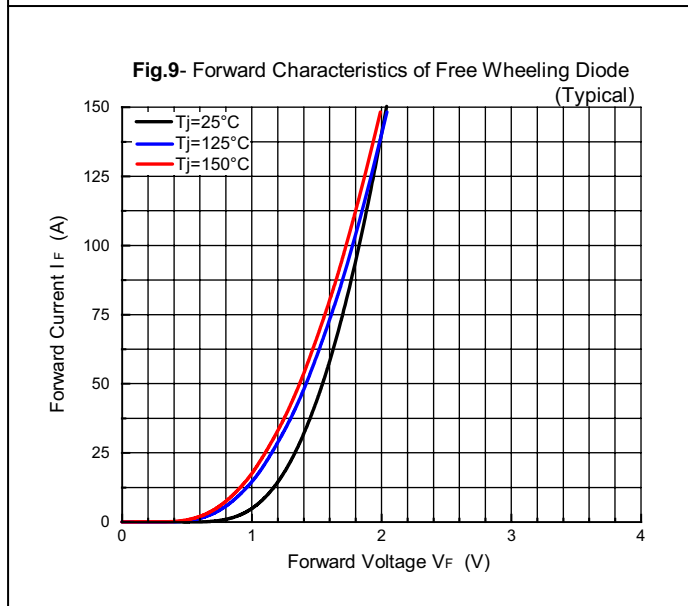
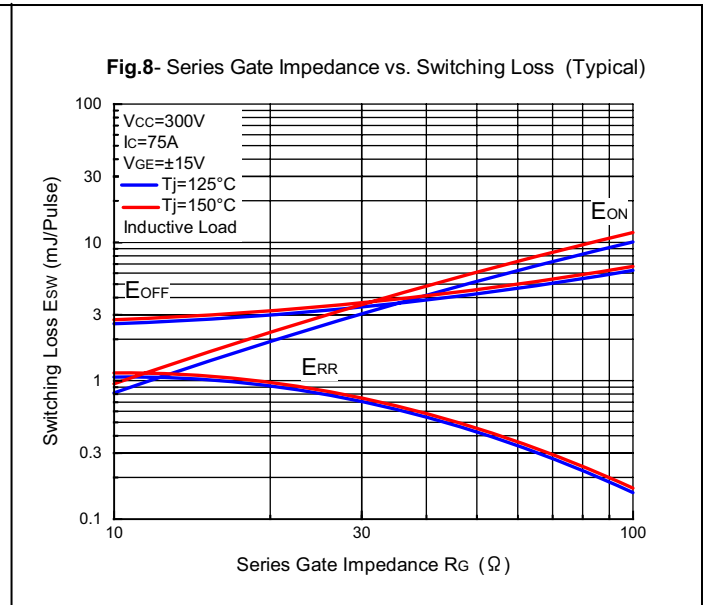
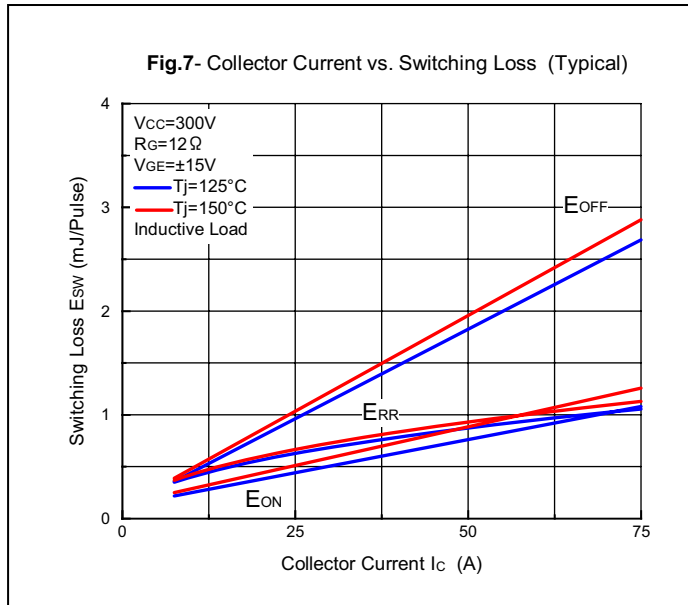
 □ 熱 的 特 性 : **THERMAL CHARACTERISTICS**

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
熱 抵 抗 Thermal Resistance	IGBT	$R_{th(j-c)}$	Junction to Case Per 1 Arm (T _c 測定点: チップ直下)	—	—	0.49	°C/W
	FWD			—	—	1.30	
接 触 熱 抵 抗 Thermal Resistance	IGBT	$R_{th(c-f)}$	Case to heatsink Per 1 Arm Paste=1W/(m ² °C)	—	0.10	—	
	FWD			—	0.17	—	

特性 : CHARACTERISTICS CURVES



特性 : CHARACTERISTICS CURVES



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